Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (Ultra-High-Speed U-MOSIII)

TPCA8016-H

High-Efficiency DC / DC Converter Applications

- Small footprint due to small and thin package
- High-speed switching
- Small gate charge: Qsw = 6.6 nC (typ.)
- Low drain-source ON resistance: R_{DS} (ON) = 16 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 40 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 10 \ \mu A (max) (V_{DS} = 60 \ V)$
- Enhancement mode: $V_{th} = 1.1$ to 2.3 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

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Characte	ristic	Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	60	V
Drain-gate voltage (R	_{GS} = 20 kΩ)	V _{DGR}	60	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	ID	25	•
Drain current	Pulsed (Note 1)	I _{DP}	75	A
Drain power dissipati	on (Tc = 25°C)	PD	45	W
Drain power dissipati	on (t = 10 s) (Note 2a)	PD	2.8	W
Drain power dissipati	on (t = 10 s) (Note 2b)	PD	1.6	W
Single pulse avalanch	ne energy (Note 3)	E _{AS}	45	mJ
Avalanche current		I _{AR}	25	А
Repetitive avalanche (1	energy ⁻ c=25°C) (Note 4)	E _{AR}	2.7	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature	range	T _{stg}	-55 to 150	°C

Absolute Maximum Ratings (Ta = 25°C)



Weight: 0.068 g (typ.)

Circuit Configuration



Note: For Notes 1to 5, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

This transistor is an electrostatic-sensitive device. Handle with care.

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Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

Marking (Note 5)



Note 1: The channel temperature should not exceed 150°C during use.

Note 2: (a) Device mounted on a glass-epoxy board (a)







Note 3: $V_{DD} = 24$ V, $T_{ch} = 25^{\circ}C$ (initial), L = 0.1 mH, $R_G = 25 \Omega$, $I_{AR} = 25$ A

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: * Weekly code: (Three digits)



Week of manufacture

(01 for the first week of the year, continuing up to 52 or 53)

 Year of manufacture (The last digit of the year)

Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 V, V_{DS} = 0 V$	_	_	±10	μA
Drain cut-OFF cu	rrent	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	10	μA
Drain-source brea	akdown voltago	V (BR) DSS	$I_{D} = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	60	_	_	V
Drain-source brea	akdown vollage	V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$		v		
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	1.1	_	2.3	V
Drain-source ON	registance	Pro (out)	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$	_	16	21	mΩ
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = 4.5 \text{ V}, I_D = 13 \text{ A}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	1115.2		
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$	20 40 —		_	S
Input capacitance	Input capacitance			_	1375	_	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	70	_	
Output capacitance		C _{oss}		_	340	_	
		Rg		_	1.0	_	Ω
Switching time	Rise time	tr	$V_{GS} \stackrel{10}{}_{0}V \qquad I_{D} = 13 \text{ A}$	_	4	_	ns
	Turn-on time	t _{on}		_	10	_	
	Fall time	t _f		_	3		
	Turn-off time	t _{off}	$V_{DD}\simeq 30~V \label{eq:VDD}$ Duty \leq 1%, $t_W=10~\mu s$		19		
Total gate charge		0	$V_{DD}\simeq 48~V,~V_{GS}=10~V,~I_{D}=25~A$		22		
(gate-source plus	e plus gate-drain) Q _g		$V_{DD}\simeq 48~V,~V_{GS}=5~V,~I_{D}=25~A$		12		
Gate-source charge 1		Q _{gs1}	$V_{DD} \simeq 48$ V, $V_{GS} = 10$ V, $I_D = 25$ A	_	4.6	_	nC
Gate-drain ("Miller") charge		Q _{gd}			4.2	_	
Gate switch char	ge	Q _{SW}		_	6.6	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Character	istic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse	(Note 1)	I _{DRP}	—	_	_	75	А
Forward voltage (diode)			VDSF	$I_{DR}=25~A,~V_{GS}=0~V$	_		-1.2	V

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Safe operating area



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